

Octal 3-STATE Buffer MM74HC244

General Description

The MM74HC244 is a non-inverting buffer and has two active low enables $(1\overline{G} \text{ and } 2\overline{G})$; each enable independently controls 4 buffers. This device does not have Schmitt trigger inputs.

These 3–STATE buffers utilize advanced silicon–gate CMOS technology and are general purpose high speed non–inverting buffers. They possess high drive current outputs which enable high speed operation even when driving large bus capacitances. These circuits achieve speeds comparable to low power Schottky devices, while retaining the advantage of CMOS circuitry, i.e., high noise immunity, and low power consumption. All three devices have a fanout of 15 LS–TTL equivalent inputs.

All inputs are protected from damage due to static discharge by diodes to V_{CC} and ground.

Features

• Typical Propagation Delay: 14 ns

• 3-STATE Outputs for Connection to System Buses

• Wide Power Supply Range: 2–6 V

• Low Quiescent Supply Current: 160 μA

• Output Current: 6 mA

• These are Pb-Free Devices

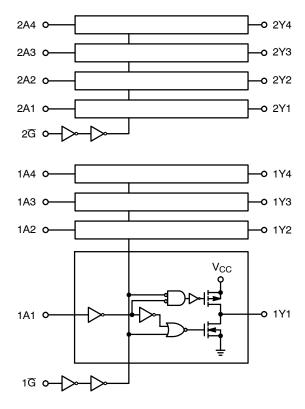


Figure 1. Logic Diagram





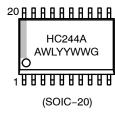


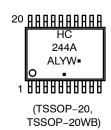
SOIC-20 CASE 751BJ

TSSOP-20 CASE 948AQ

TSSOP-20 WB CASE 948E

MARKING DIAGRAMS



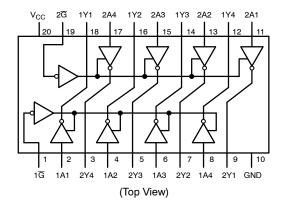


HC240A = Specific Device Code A = Assembly Location

L/WL = Wafer Lot Y/YY = Year W/WW = Work Week ■ or G = Pb-Free Package

(Note: Microdot may be in either location)

CONNECTION DIAGRAM



TRUTH TABLE

| 1 G | 1A | 1Y | 2G | 2A | 2Y |
|----------------|----|----|----|----|----|
| L | L | L | L | L | L |
| L | Н | Н | L | Н | Н |
| Н | L | Z | Н | L | Z |
| Н | Н | Z | Н | Н | Z |

H = HIGH Level

L = LOW Level

Z = HIGH Impedance

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 4 of this data sheet.

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MM74HC244

MAXIMUM RATINGS (Note 1)

| Symbol | Parameter | Value | Unit |
|-----------------------------------|---|-------------------------------|------|
| V _{CC} | Supply Voltage | −0.5 to +6.5 | V |
| V _{IN} | DC Input Voltage | -0.5 to V _{CC} + 0.5 | V |
| V _{OUT} | DC Output Voltage | -0.5 to V _{CC} + 0.5 | V |
| I _{IK} , I _{OK} | Clamp Diode Current | ±20 | mA |
| l _{out} | DC Output Current, per Pin | ±35 | mA |
| I _{CC} | DC VCC or GND Current, per Pin | ±70 | mA |
| T _{STG} | Storage Temperature Range | −65 to +150 | °C |
| P _D | Power Dissipation SOIC-20W TSSOP-20 | 1302 833 | mW |
| TL | Lead Temperature (Soldering 10 seconds) | 260 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Unless otherwise specified all voltages are referenced to ground.

RECOMMENDED OPERATIONG CONDITIONS (Note 1)

| Symbol | Parameter | Min | Max | Unit |
|------------------------------------|---|-----|--------------------|------|
| V _{CC} | Supply Voltage | 2 | 6 | V |
| V _{IN} , V _{OUT} | DC Input or Output Voltage | 0 | V _{CC} | V |
| T _A | Operating Temperature Range | -55 | +125 | °C |
| t _r , t _f | Input Rise or Fall Times V _{CC} = 2.0 V V _{CC} = 4.5 V V _{CC} = 6.0 V | | 1000 500 400 | ns |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS (Note 2)

| | | | V _{CC} | T _A = | 25°C | $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le 85^{\circ}\text{C}$ | -55°C ≤ T _A ≤ 125°C | |
|-----------------|--------------------------------------|--|-------------------|-------------------|-----------------------|--|--------------------------------|------|
| Symbol | Parameter | Conditions | (V) | Тур | Typ Guaranteed Limits | | mits | Unit |
| V _{IH} | Minimum HIGH Level Input Voltage | | 2.0 4.5 6.0 | - - - | 1.5 3.15 4.2 | 1.5 3.15 4.2 | 1.5 3.15 4.2 | V |
| V _{IL} | Maximum LOW Level Input Voltage | | 2.0 4.5 6.0 | - - - | 0.5 1.35 1.8 | 0.5 1.35 1.8 | 0.5 1.35 1.8 | ٧ |
| V _{OH} | Minimum HIGH Level Output Voltage | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} \le 20 \ \mu\text{A}$ | 2.0 4.5 6.0 | 2.0 4.5 6.0 | 1.9 4.4 5.9 | 1.9 4.4 5.9 | 1.9 4.4 5.9 | ٧ |
| | | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} \le 6.0 \text{ mA}$ $ I_{OUT} \le 7.8 \text{ mA}$ | 4.5 6.0 | 4.2 5.7 | 3.98 5.4 | 3.84 5.34 | 3.7 5.2 | ٧ |
| V _{OL} | Maximum LOW Level Output Voltage | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} \le 20 \ \mu\text{A}$ | 2.0 4.5 6.0 | 0 0 0 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | V |
| | | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} \le 6.0 \text{ mA}$ $ I_{OUT} \le 7.8 \text{ mA}$ | 4.5 6.0 | 0.2 0.2 | 0.26 0.26 | 0.33 0.33 | 0.4 0.4 | ٧ |
| I _{IN} | Maximum Input Current | V _{IN} = V _{CC} or GND | 6.0 | ı | ±0.1 | ±1.0 | ±1.0 | μΑ |

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DC ELECTRICAL CHARACTERISTICS (Note 2) (continued)

| | | | V _{CC} | T _A = | 25°C | $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le 85^{\circ}\text{C}$ | $-55^{\circ}\text{C} \le \text{T}_{\text{A}} \le 125^{\circ}\text{C}$ | |
|-----------------|--|---|-----------------|------------------|-------------------|--|---|----|
| Symbol | Parameter | Conditions | (V) | Тур | Guaranteed Limits | | Unit | |
| l _{OZ} | Maximum 3-STATE Output Leakage Cur- rent | $V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND $\overline{G} = V_{IH}$ | 6.0 | ı | ±0.5 | ±5 | ±10 | μΑ |
| I _{CC} | Maximum Quiescent Supply Current | $V_{IN} = V_{CC}$ or GND $I_{OUT} = 0 \mu A$ | 6.0 | - | 8.0 | 80 | 160 | μΑ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | Conditions | Тур | Guaranteed Limit | Unit |
|-------------------------------------|--|--|-----|---------------------|------|
| t _{PHL} , t _{PLH} | Maximum Propagation Delay | C _L = 45 pF | 14 | 20 | ns |
| t _{PZH} , t _{PZL} | Maximum Enable Delay to Active Output | R_L = 1 kΩ, C_L = 45 pF | 17 | 28 | ns |
| t _{PHZ} , t _{PLZ} | Maximum Disable Delay from Active Output | $R_L = 1 \text{ k}\Omega$, $C_L = 5 \text{ pF}$ | 15 | 25 | ns |

AC ELECTRICAL CHARACTERISTICS (V_{CC} = 2.0 V to 6.0 V, C_L = 50 pF, t_r = t_f = 6 ns (unless otherwise specified))

| | | | V _{CC} | T _A = | 25°C | $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le 85^{\circ}\text{C}$ | $-55^{\circ}C \leq T_{A} \leq 125^{\circ}C$ | |
|--|--|--|-------------------|------------------|-----------------|--|---|------|
| Symbol | Parameter | Conditions | (V) | Тур | | Guaranteed L | imits | Unit |
| t _{PHL} , t _{PLH} | Maximum Propagation Delay | C _L = 50 pF C _L = 150 pF | 2.0 2.0 | 58 83 | 115 165 | 145 208 | 171 246 | ns |
| | | C _L = 50 pF C _L = 150 pF | 4.5 4.5 | 14 17 | 23 33 | 29 42 | 34 49 | ns |
| | | C _L = 50 pF C _L = 150 pF | 6.0 6.0 | 10 14 | 20 28 | 25 35 | 29 42 | ns |
| t _{PZH} , t _{PZL} | Maximum Output Enable Time | $R_L = 1 \text{ k}\Omega$ $C_L = 50 \text{ pF}$ $C_L = 150 \text{ pF}$ | 2.0 2.0 | 75 100 | 150 200 | 189 252 | 224 298 | ns |
| | | C _L = 50 pF C _L = 150 pF | 4.5 4.5 | 15 30 | 30 40 | 38 50 | 45 60 | ns |
| | | C _L = 50 pF C _L = 150 pF | 6.0 6.0 | 13 17 | 26 34 | 32 43 | 38 51 | ns |
| t _{PHZ} , t _{PLZ} | Maximum Output Disable Time | $R_L = 1 \text{ k}\Omega$ $C_L = 50 \text{ pF}$ | 2.0 4.5 6.0 | 75 15 13 | 150 30 26 | 189 38 32 | 224 45 38 | ns |
| t _{TLH} , t _{THL} | Maximum Output Rise and Fall Time | | 2.0 4.5 6.0 | - - - | 60 12 10 | 75 15 13 | 90 18 15 | ns |
| C _{PD} | Power Dissipation Capacitance (Note 3) | (per buffer) G = V _{IH} G = V _{IL} | - - | 12 50 | - - | - - | - - | pF |
| C _{IN} | Maximum Input Capacitance | | - | 5 | 10 | 10 | 10 | pF |
| C _{OUT} | Maximum Output Capacitance | | - | 10 | 20 | 20 | 20 | pF |

^{3.} C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \cdot V_{CC}^2 \cdot f + I_{CC} \cdot V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \cdot V_{CC} \cdot f + I_{CC}$.

For a power supply of 5 V ±10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5 V. Thus the 4.5 V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5 V and 4.5 V respectively. (The V_{IH} value at 5.5 V is 3.85 V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0 V values should be used.

MM74HC244

ORDERING INFORMATION

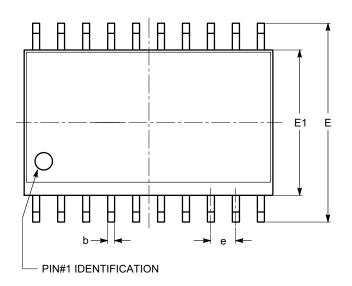
| Device | Package | Shipping [†] |
|---------------|--------------------------|-----------------------|
| MM74HC244WM | SOIC-20 (Pb-Free) | 38 Units / Tube |
| MM74HC244WMX | SOIC-20 (Pb-Free) | 1000 / Tape & Reel |
| MM74HC244MTC | TSSOP-20 WB (Pb-Free) | 75 Units / Tube |
| MM74HC244MTCX | TSSOP-20 (Pb-Free) | 2500 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



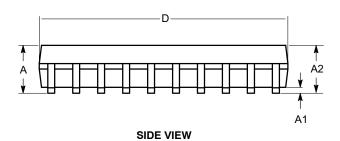
SOIC-20, 300 mils CASE 751BJ ISSUE O

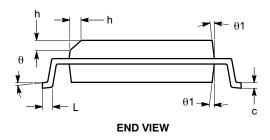
DATE 19 DEC 2008



| SYMBOL | MIN | NOM | MAX |
|--------|-------|----------|-------|
| А | 2.36 | 2.49 | 2.64 |
| A1 | 0.10 | | 0.30 |
| A2 | 2.05 | | 2.55 |
| b | 0.31 | 0.41 | 0.51 |
| С | 0.20 | 0.27 | 0.33 |
| D | 12.60 | 12.80 | 13.00 |
| E | 10.01 | 10.30 | 10.64 |
| E1 | 7.40 | 7.50 | 7.60 |
| е | | 1.27 BSC | |
| h | 0.25 | | 0.75 |
| L | 0.40 | 0.81 | 1.27 |
| θ | 0° | | 8° |
| θ1 | 5° | | 15° |

TOP VIEW





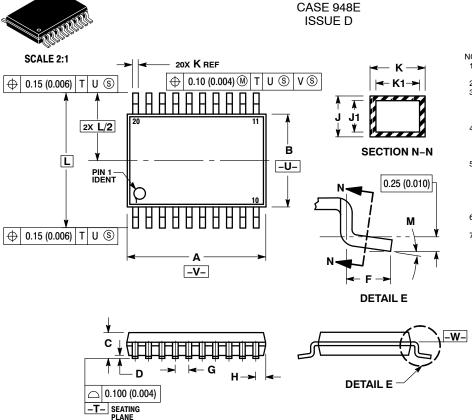
Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MS-013.

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| DESCRIPTION: | SOIC-20, 300 MILS | | PAGE 1 OF 1 | | |

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TSSOP-20 WB

DATE 17 FEB 2016

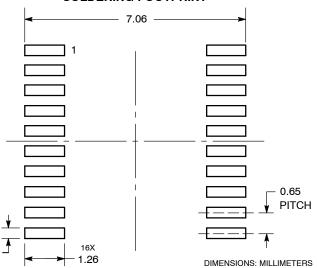
NOTES:

- NOTES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT
- EXCEED 0.15 (0.006) PER SIDE.
 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.
 INTERLEAD FLASH OR PROTRUSION
- SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

 5. DIMENSION K DOES NOT INCLUDE
 DAMBAR PROTRUSION, ALLOWABLE
 DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K
 DIMENSION AT MAXIMUM MATERIAL CONDITION.
 TERMINAL NUMBERS ARE SHOWN FOR
- TERMINAL NOMBERS ARE SHOWN FOR REFERENCE ONLY.
 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE –W–.

| | MILLIN | IETERS | INCHES | | |
|-----|--------|--------|-----------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 6.40 | 6.60 | 0.252 | 0.260 | |
| В | 4.30 | 4.50 | 0.169 | 0.177 | |
| С | | 1.20 | | 0.047 | |
| D | 0.05 | 0.15 | 0.002 | 0.006 | |
| F | 0.50 | 0.75 | 0.020 | 0.030 | |
| G | 0.65 | BSC | 0.026 BSC | | |
| Н | 0.27 | 0.37 | 0.011 | 0.015 | |
| J | 0.09 | 0.20 | 0.004 | 0.008 | |
| J1 | 0.09 | 0.16 | 0.004 | 0.006 | |
| K | 0.19 | 0.30 | 0.007 | 0.012 | |
| K1 | 0.19 | 0.25 | 0.007 | 0.010 | |
| L | 6.40 | | 0.252 BSC | | |
| M | 0° | 8° | 0° | 8° | |

GENERIC RECOMMENDED MARKING DIAGRAM* SOLDERING FOOTPRINT*



| | ALYW• | |
|---|---------------------|----|
| | 0 • | |
| | <u> </u> | |
| A | = Assembly Location | or |

8888888888

XXXX XXXX

= Water Lot = Year

= Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

| *For additional information on our Pb-Free strategy and soldering |
|---|
| details, please download the onsemi Soldering and Mounting |
| Techniques Reference Manual, SOLDERRM/D. |

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|------------------|-------------|---|-------------|
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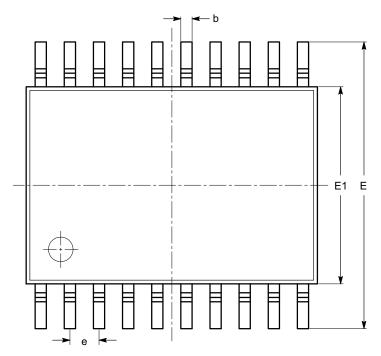
16X

0.36



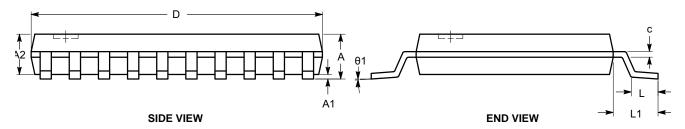
TSSOP20, 4.4x6.5 CASE 948AQ ISSUE A

DATE 19 MAR 2009



| SYMBOL | MIN | NOM | MAX |
|--------|------|----------|------|
| А | | | 1.20 |
| A1 | 0.05 | | 0.15 |
| A2 | 0.80 | | 1.05 |
| b | 0.19 | | 0.30 |
| С | 0.09 | | 0.20 |
| D | 6.40 | 6.50 | 6.60 |
| Е | 6.30 | 6.40 | 6.50 |
| E1 | 4.30 | 4.40 | 4.50 |
| е | | 0.65 BSC | |
| L | 0.45 | 0.60 | 0.75 |
| L1 | | 1.00 REF | |
| θ | 0° | | 8° |

TOP VIEW



Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-153.

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